Form PTO-1595 (Rev. 09/ 64) OMB No. 0651-0027 (exp. 6/30/2005)	U.S. DEPARTMENT OF COMP United States Patent and Trademar			
RECORDATION FOR				
PATENTS ONLY				
To the Director of the U.S. Patent and Trademark Office: Please	record the attached documents or the new address(es) be	low.		
1. Name of conveying party(ies)/Execution Date(s):	2. Name and address of receiving party(ies)			
KAZUSHIGE TAKAHASHI (09/17/2008),				
HIROMASA IKEYAMA (09/18/2008).				
MANABU HARA (09/17/2008), AND	Name: SONY CORPORATION			
	Internal Address:			
Execution Date(s): in parentheses after inventor name	Street Address:			
Additional name(s) of conveying party(ies) attached? X Yes No	1-7-1 Konan, Minato-ku			
3. Nature of Conveyance:	Tokyo 108-0075			
X Assignment Merger	JAPAN			
Security Agreement Change of Name	City:			
Government Interest Assignment	State:			
Executive Order 9424, Confirmatory License	Country: Zip:			
	Additional name(s) & address(es) Yes X No	······		
Other	attached.			
4. Application or patent number(s):	This document is being filed together with a new application	ή.		
A. Patent Application No.(s)	B. Patent No.(s)			
12/287,926				
Additional numbers attached?	Yes X No			
5. Name and address to whom correspondence	6. Total number of applications and patents involved:			
concerning document should be mailed: Name: Dennis M. Smid, Esq.	patric involved.			
LERNER, DAVID, LITTENBERG,				
KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00_			
1				
Internal Address: Atty. Dkt.: SONYJP 3.0-1719	Authorized to be charged by credit card			
Street Address: 600 South Avenue Mort				
Street Address: 600 South Avenue West	X Authorized to be charged to deposit account			
	Enclosed			
	None required (government interest not affecting	g title)		
City: Westfield	8. Payment Information			
State: NJ Zip: 07090	a. Credit Card Last 4 Numbers			
Phone Number: (908) 518-6374	Expiration Date			
Fax Number: (908) 654-0415	b. Deposit Account Number 12-1095			
Email Address: dsmid@ldlkmycom	Authorized User Name Dennis M. Smid, Esq			
9. Signature:				
<u> </u>	September 20, 2010	:		
Signature	Date	1		
Dennis M. Smid, Esq 34,930 Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:	4		
1				

1258035

PATENT REEL: 025018 FRAME: 0331

Form PTO-1595	RECOR	RDATION FORM COVER SHEET (continued)	WWW.
Additional Conveyin	g Party(ies)/Exe	cution Date(s) (1. Continued):	
Yukihiro Kinoshita (09/	19/2008)		
Additional Assignee	s (2. Continued)	•	
Assignee Name: Internal Address: Street Address:			dadama's provinces
City:	Stałe:	Country:	Ziρ:
	State:	Country:	
Assignee Name: Internal Address: Street Address:	35dH947p		······································
City:	State:	Country:	Zip:
Additional Application	ons and/or Pater	nts (4. Continued):	
Additional Patent Application 4A, Continued:		Additional Patent Numbers 4B. Continued:	
	Additional numbe	ers attached? Yes No	

2

Docket No.: SONYJP 3.0-1719

LDLKM

→ USPTO ASSIGNMENT 2004/005 SOBP1526USOO SONYJP 3.0-1719 Docket Number:

ASSIGNMENT

WHEREAS, I, as a	below named inventor, resid	ling at the address stated ne	xt to my name, am a sole inventor (if
only one name is listed below) or a j	oint inventor (if plural name:	are listed below) of certain	new and useful improvements in
NOISE CORRECTION CIRCUIT,	IMAGING APPARATUS,	AND NOISE CORRECT	ON METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficience of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer onto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby anthorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remoneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall be reafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encombrance has been or will be made or entered into which would conflict with this assignment and sale.

This assignment executed on the dates indicated below.

Kazushige TAKAHASHl	
Mone of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor	
<u>Krizmahiye Takahashi</u> Bignature of first or sole inventor	Sup. 17., 2008 Date of this assignment

PATENT REEL: 025018 FRAME: 0333

RECORDED: 09/20/2010

S08P1526US00

Hiromasa IKEYAMA	
Name of second inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of second inventor	
History Cheyana Signature of second inventor	Soy, 18, 2008 Date of this assignment
Signature of second inventor	Date of this assignment
Manabu HARA	
Name of third inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of third inventor	
Mara ba Itara	Seys 17. 2005 Date of this assignment
Mana ba Haza Signature of third inventor	Date of this assignment
Yukihiro KINOSHITA Name of fourth inventor	Signature data of U.S. Detent Application
	Execution date of U.S. Patent Application
Kanagawa, Japan Residence of fourth inventor	
Signature of fourth inventor	Nep / 9 2008 Date of this assignment
Signature of fourth inventor	Date of this assignment
Name of lifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
совоенов от шил шуударг	
Signature of fifth inventor	Date of this assignment

PATENT REEL: 025018 FRAME: 0334